



MAIL STOP RCE
PATENT
8053-1015

IN THE U.S. PATENT AND TRADEMARK OFFICE

In re application of

Takekazu TANAKA

Conf. 1342

Application No. 10/602,044

Group 2814

Filed June 24, 2003

Examiner Alonzo Chambliss

SEMICONDUCTOR PACKAGE, AND
PRODUCTION PROCESS FOR
MANUFACTURING SUCH SEMICONDUCTOR
PACKAGE

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

July 3, 2006

Sir:

In response to the Office Action mailed April 5, 2006,
please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing
of claims which begins on page 2 of this paper.

Remarks begin on page 7 of this paper.